04-10-2003 Atty Docket No.: 233349US-6 FOR M PTO-1595 U.S. DEPARTMENT OF COMMERCE 1-31-92 Patent and Trademark Office To the Honorable Commissioner of Patents and nal documents or copy thereof. 102414784 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): 1)Masato HATTORI 2) Seiji OHBI 3) Takashi KAWAKAMI SONY CORPORATION Name: 4) Manabu KII Address: 7-35, Kitashinagawa 6-chome 4-1-03 Shinagawa-ku, Tokyo, JAPAN Additional name(s) of conveying party(ies) attached? \(\subseteq\) Yes \(\boxed{\omega}\) No 3. Nature of Conveyance: Assignment ☐ Merger ☐ Security Agreement ☐ Change of Name ☐ Other Execution Date: 3-18-03 Additional name(s) and address(es) attached?

Yes No 4. Application number(s) or patent number(s): 10402924 If this document is being filed together with a new application, the execution date of the application is: 3-18-03 A. Patent Application No.(s) B. Patent No.(s) Additional numbers attached?

Yes No 5. Name and address of party to whom correspondence 6. Total applications and patents involved: 1 concerning document should be mailed: 7. Total fee (37 CFR 3.41): \$40.00 Enclosed ☐ Authorized to be charged to deposit account 8. Deposit account number: 15-0030 Tel. (703) 413-3000 (Attach duplicate copy of this page if paying by deposit account) Fax. (703) 413-2220 DO NOT USE THIS SPACE 9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Bradley D. Lytle Name of Person Signing Registration Number: 40,073 Total number of pages including this cover sheet: 3 Do not detach this portion

Commissioner of Patents and Trademarks
Box Assignments
Washington, D.C. 20231

GJM:BDL:fb1 1:\NEW APPLICATION\233349.ASSIGNEMENT.DOC

Mail documents to be recorded with required cover sheet information to:

PATENT REEL: 013927 FRAME: 0136

Docket Number:

ASSIGNIVIENI
WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in RECORDING METHOD, AND STORAGE MEDIUM DRIVING APPARATUS
for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;
AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of A SIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or ressues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and propage at its own expense;
And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents re ating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and ac essible to me and will testify as to the same in any interference or litigation related thereto;
And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which we uld conflict with this assignment and sale.
And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number:, Filing Date:
This assignment executed on the dates indicated below.
MASATO HATTORI
Name of first or sole inventor Execution date of U.S. Patent Application
KANAGAWA, JAPAN
Residence of first or sole inventor Mor 18, 2003 Signature of first or sole inventor Date of this assignment
Signature of first or sole inventor Date of this assignment

PATENT REEL: 013927 FRAME: 0137

SEIJI OHBI	
Name of second inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of second inventor	
la Coloni	Mars 18- 2003
Signature of second inventor	Mar 18, 2003 Date of this assignment
TAKASHI KAWAKAMI	
Name of third inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of third inventor	
Tokadai Ranakan	Man (8, 2003 Date of this assignment
Signature of third inventor	Date of this assignment
MANABU KII	
Name of fourth inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of fourth inventor	,
Residence of fourth inventor 'Manual Jan Signature of fourth inventor	Mar 18, 2003 Date of this assignment
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

PATENT REEL: 013927 FRAME: 0138

RECORDED: 04/01/2003